

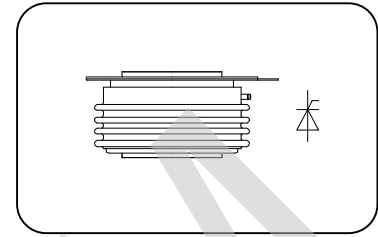
Features:

- n Interdigitated amplifying gates
- n Fast turn-on and high di/dt
- n Low switching losses

Typical Applications

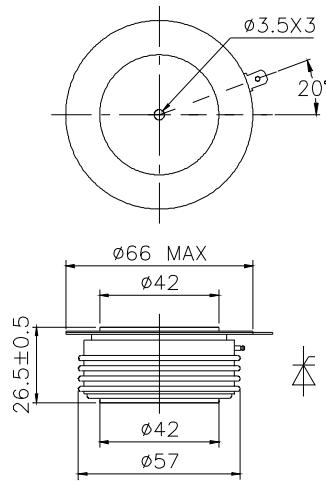
- n Inductive heating
- n Electronic welders
- n Self-commutated inverters

$I_{T(AV)}$	820A
V_{DRM}/V_{RRM}	800~1800V
t_q	12~18μs
I_{TSM}	8.5KA
I^2t	361 10³A²S



SYMBOL	CHARACTERISTIC	TEST CONDITIONS	T _J (°C)	VALUE			UNIT
				Min	Type	Max	
$I_{T(AV)}$	Mean on-state current	180° half sine wave 50Hz Double side cooled, T _{hs} =55°C	125			820	A
V_{DRM} V_{RRM}	Repetitive peak off-state voltage Repetitive peak reverse voltage	V_{DRM} & V_{RRM} , tp=10ms V_{DSM} & $V_{RSM}= V_{DRM}$ & V_{RRM} +100V	125	800		1800	V
I_{DRM} I_{RRM}	Repetitive peak current	$V_D= V_{DRM}$ $V_R= V_{RRM}$	125			50	mA
I_{TSM}	Surge on-state current	10ms half sine wave	125			8.5	KA
I^2t	I ² T for fusing coordination					361	A ² s*10 ³
V_{TO}	Threshold voltage		125			1.70	V
r_T	On-state slop resistance					0.48	mW
V_{TM}	Peak on-state voltage	$I_{TM}=1500A$, F=18KN	125			2.42	V
dv/dt	Critical rate of rise of off-state voltage	$V_{DM}=0.67V_{DRM}$	125			500	V/μs
di/dt	Critical rate of rise of on-state current	$V_{DM}= 67\%V_{DRM}$ to 1600A, Gate pulse t _r ≤ 0.5 μ s I _{GM} =1.5A Repetitive	125			300	A/μs
I_{rm}	Reverse recovery current	$I_{TM}=800A$, tp=1000μs, di/dt=-20A/μs, $V_R=50V$	125			70	A
t _{rr}	Reverse recovery time					4.4	μs
Q _{rr}	Recovery charge					155	180
t _q	Circuit commutated turn-off time	$I_{TM}=800A$, tp=1000μs, $V_R=50V$ dv/dt=30V/μs ,di/dt=-20A/μs	125	12		18	μs
I_{GT}	Gate trigger current	$V_A=12V$, I _A =1A	25	40		250	mA
V_{GT}	Gate trigger voltage			0.9		2.5	V
I_H	Holding current			20		400	mA
V_{GD}	Non-trigger gate voltage	$V_{DM}=67\%V_{DRM}$	125	0.3			V
R _{th(j-h)}	Thermal resistance Junction to heat sink	At 180° sine' double side cooled Clamping force 18KN				0.032	°C /W
F _m	Mounting force			15		20	KN
T _{stg}	Stored temperature			-40		140	°C
W _t	Weight					360	g
Outline	KT39cT40						

Outline:



TECHSEM